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<input type="checkbox"/>	L4	L2 and (first with anneal\$3) and (second with anneal\$3)	200
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<input type="checkbox"/>	L2	L1 and implant\$5	2609
		((wafer or substrate) with bond\$3) and ((heat\$3 or anneal\$3 or thermal\$4)	
<input type="checkbox"/>	L1	with (delaminat\$4 or detach\$4 or split\$4 or separat\$4 or cleav\$3 or bubbl\$2 or crack\$3))	20470

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L9 and (thermal adj budget)

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L10 L9 and (thermal adj budget)29 L10L9 smart adj cut568 L9

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L8 6828216.pn.1 L8L7 6335258.pn.1 L7L6 L5 and (split\$4 or separat\$4 or cleav\$4 or detach\$4 or delaminat\$5)317 L6L5 L4 and (lower or less)362 L5L4 L3 and thermal397 L4L3 L2 and (hydrogen or ion)487 L3L2 L1 and temperature and time721 L2L1 438/4,455,458.ccls.1223 L1

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| <input type="checkbox"/> | <p><b>1. New semiconductor hetero-substrates for high temperature applications using the Smart-Cut(R) tech</b><br/> Aspar, B.; Joly, J.-P.; Jaussaud, C.; di Cioccio, L.; Bruel, M.; Moriceau, H.; Letertre, F.; Hugonnard-Bruyere, E<br/> High Temperature Electronics, 1999. HITEN 99. The Third European Conference on<br/> 4-7 July 1999 Page(s):67 - 73<br/> <a href="#">AbstractPlus</a>   Full Text: <a href="#">PDF(248 KB)</a> IEEE CNF</p>                                 |
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| <input type="checkbox"/> | <p><b>3. Electrolytes for Li-ion cells in low temperature applications</b><br/> Smart, M.C.; Ratnakumar, B.V.; Surampudi, S.;<br/> Battery Conference on Applications and Advances, 1999. The Fourteenth Annual<br/> 12-15 Jan. 1999 Page(s):55 - 60<br/> <a href="#">AbstractPlus</a>   Full Text: <a href="#">PDF(360 KB)</a> IEEE CNF</p>   |
| <input type="checkbox"/> | <p><b>4. Performance characteristics of Yardney lithium-ion cells for the Mars 2001 Lander application</b><br/> Smart, M.C.; Ratnakumar, B.V.; Whitcanacka, L.; Surampudia, S.; Lowry, L.; Gitzendanner, R.; Marsh, C.; Pu<br/> Marsh, R.;<br/> Energy Conversion Engineering Conference and Exhibit, 2000. (IECEC) 35th Intersociety<br/> Volume 1, 24-28 July 2000 Page(s):629 - 637 vol.1<br/> <a href="#">AbstractPlus</a>   Full Text: <a href="#">PDF(784 KB)</a> IEEE CNF</p> |
| <input type="checkbox"/> | <p><b>5. Plasma-assisted InP-to-Si low temperature wafer bonding</b><br/> Pasquariello, D.; Hjort, K.;<br/> Selected Topics in Quantum Electronics, IEEE Journal of<br/> Volume 8, Issue 1, Jan.-Feb. 2002 Page(s):118 - 131<br/> <a href="#">AbstractPlus</a>   <a href="#">References</a>   Full Text: <a href="#">PDF(443 KB)</a> IEEE JNL</p>  |
| <input type="checkbox"/> | <p><b>6. Optoelectronic refractive index measurements: application to smart processing</b><br/> Cusano, A.; Cutolo, A.; Giordano, M.; Nicolais, L.;<br/> Sensors Journal, IEEE<br/> Volume 3, Issue 6, Dec. 2003 Page(s):781 - 787<br/> <a href="#">AbstractPlus</a>   <a href="#">References</a>   Full Text: <a href="#">PDF(441 KB)</a> IEEE JNL</p>  |